

TOSHIBA Fast Recovery Diode Silicon Diffused Type

## S5295B, S5295G, S5295J

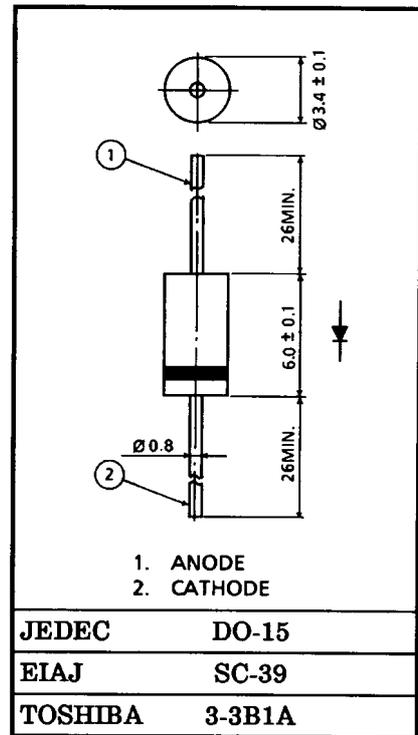
High Speed Rectifier Applications (fast recovery)

Unit in mm

- Average Forward Current:  $I_F (AV) = 0.5 \text{ A}$  ( $T_a = 50^\circ\text{C}$ )
- Repetitive Peak Reverse Voltage:  $V_{RRM} = 100, 400, 600 \text{ V}$
- Reverse Recovery Time:  $1.5 \mu\text{s}$
- Plastic Mold Type.

### Maximum Ratings

Characteristics		Symbol	Rating	Unit
Repetitive peak reverse voltage	S5295B	$V_{RRM}$	100	V
	S5295G		400	
	S5295J		600	
Reverse voltage (DC)	S5295B	$V_R$	75	V
	S5295G		300	
	S5295J		500	
Average forward current ( $T_a = 50^\circ\text{C}$ )		$I_F (AV)$	0.5	A
Peak one cycle surge forward current (non repetitive)		$I_{FSM}$	30 (50 Hz)	A
			33 (60 Hz)	
Junction temperature		$T_j$	-40 to 125	$^\circ\text{C}$
Storage temperature range		$T_{stg}$	-40 to 125	$^\circ\text{C}$



Weight : 0.42 g

### Electrical Characteristics ( $T_a = 25^\circ\text{C}$ )

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Peak forward voltage	$V_{FM}$	$I_{FM} = 1.0 \text{ A}$	—	—	1.5	V
Repetitive peak reverse current	$I_{RRM}$	$V_{RRM} = \text{Rated}$	—	—	10	$\mu\text{A}$
Reverse recovery time	$t_{rr}$	$I_F = 20 \text{ mA}, I_R = 1 \text{ mA}$	—	—	1.5	$\mu\text{s}$
Forward recovery voltage	$V_{fr}$	$I_F = 100 \text{ mA}, t_r = 100 \text{ ns}, t_w = 5 \mu\text{s}$	—	—	10	V

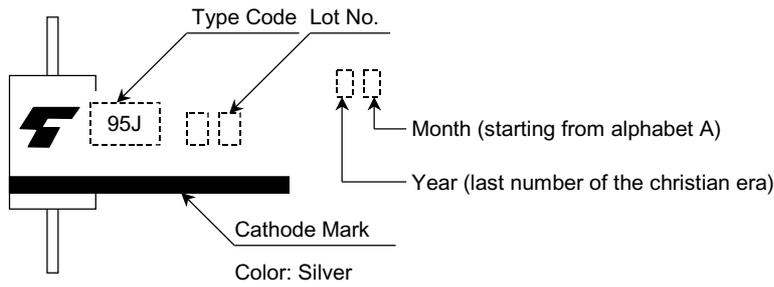
Note1: Soldering: 5 mm is the minimum to be kept between case and soldering part.

Note2: Lead bending: 5 mm is the minimum to be kept from the case when bend the lead wire.

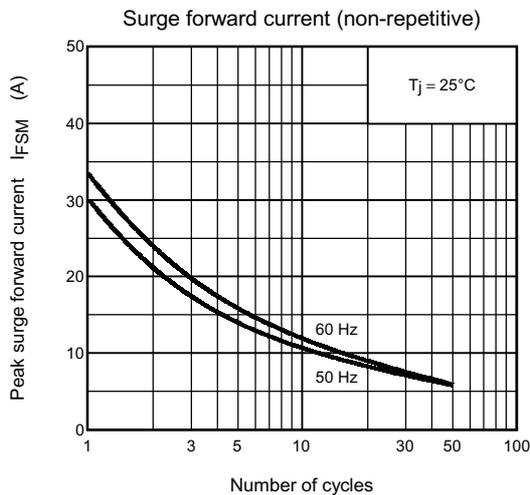
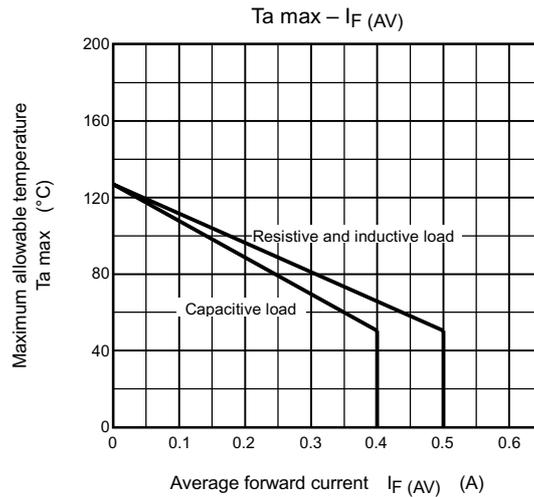
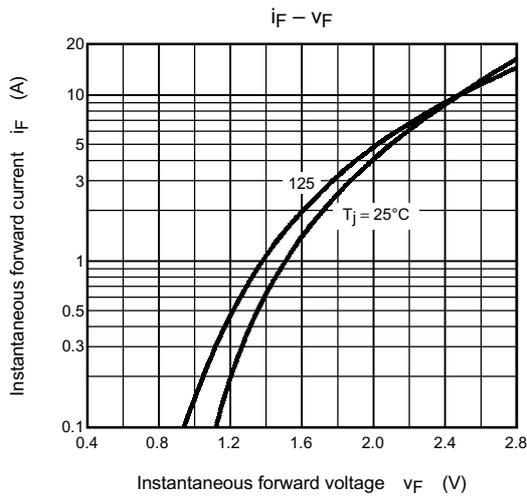
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## Marking



Code	Type
95B	S5295B
95G	S5295G
95J	S5295J



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